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| ISSUE CLASSIFICATION | |
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| Class | Subclass |
| | |

PATENT NUMBER

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| <p>O.I.P.E.</p> <p>SCANNED <i>ACI</i> G.A. <i>ALL</i></p> | <p>PATENT DATE</p> |
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| APPLICATION NO. 09/923394 | CONT/PRIOR F | CLASS 257 | SUBCLASS 686 | ART UNIT 2855 | EXAMINER H. H. ERDEM |
|------------------------------|-----------------|--------------|-----------------|------------------|-------------------------|

Koki Hirasawa
Hiroyuki Kikawa

Lead frame, semiconductor device
produced by using the same and
method of
producing the semiconductor device

PTO-2040
12/99[illegible]

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|---|--|--------------|------------|-----------------------------------|----------------------|
| TERMINAL DISCLAIMER | DRAWINGS | | | CLAIMS ALLOWED | |
| | Sheets Drawg. | Figs. Drawg. | Print Fig. | Total Claims | Print Claim for O.G. |
| <input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed. | _____ (Assistant Examiner) (Date) | | | NOTICE OF ALLOWANCE MAILED | |
| <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____ | _____ (Primary Examiner) (Date) | | | ISSUE FEE | |
| | | | | Amount Due | Date Paid |
| <input type="checkbox"/> The terminal _____ months of this patent have been disclaimed. | _____ (Legal Instruments Examiner) (Date) | | | ISSUE BATCH NUMBER | |

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